JAE Electronics, Inc.
October 26th, 2026

ENG-E26-129 - Distributors

PCN (Process Change Notice)
MX34E08NF1
Replacement stamp die (563161-002)
To Keep Production Capacity

Part Number	Existing Stamp Die	Replacement Stamp Die Will Be Created	Completion of Replacement Stamp Die	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34E08NF1	563161-001	563161-002 to replace 563161-001 when reaches to EOL	Completed	March 2027	After receiving approvals from all customers

Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc…)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received initial PPAP.
2. If you request PC PPAP documents for this notification, please notify us ASAP.

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